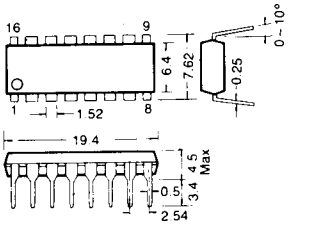
Quad 2-Line to 1-Line Data Selector/Multiplexers

16 Dip Unit: mm



These are data selector/multiplexers which select a 4-bit word from one of two sources via the control of a common select input ($\overline{A}$/B). A separate strobe input ($\overline{G}$) is provided. The '157 presents true data whereas the '158 presents inverted data at the outputs.

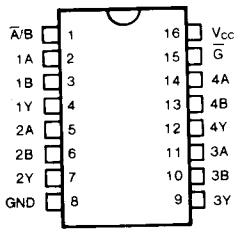
These devices provide speeds and drive capability equivalent to their ALSTTL counterparts and yet maintain CMOS power levels. The input and output voltage levels allow direct interface with TTL, NMOS and CMOS devices without any external components.

All inputs and outputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

FEATURES

- **Function, pin-out, speed and drive compatibility with 54/74ALS logic family**
- **Low power consumption characteristic of CMOS**
- **High-Drive-Current outputs:**
  I_{OL} = 8 mA @ V_{OL} = 0.5V
- **Inputs and outputs interface directly with TTL, NMOS and CMOS devices**
- **Wide operating voltage range: 4.5V to 5.5V**
- **Characterized for operation over industrial and military temperature ranges:**
  KS74AHCT: −40°C to +85°C
  KS54AHCT: −55°C to +125°C

PIN CONFIGURATION

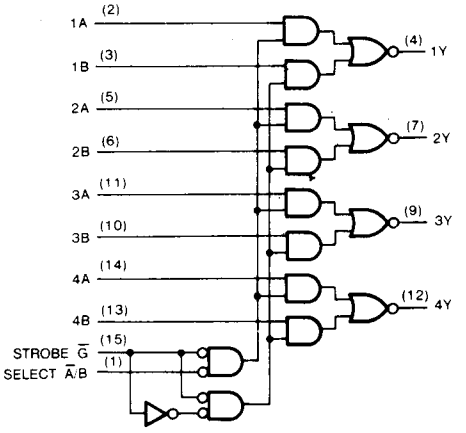


FUNCTION TABLE

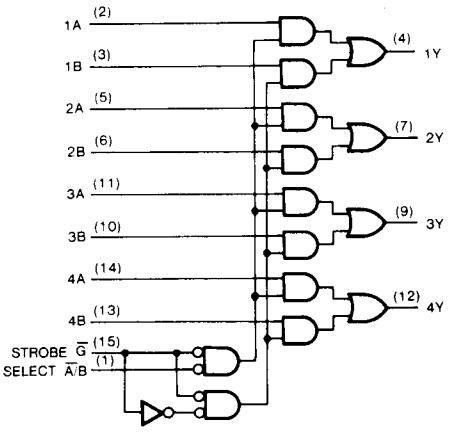
Inputs				Output Y	
Strobe	Select	Data		'157	'158
$\overline{G}$	$\overline{A}$/B	A	B		
H	X	X	X	L	H
L	L	L	X	L	H
L	L	H	X	H	L
L	H	X	L	L	H
L	H	X	H	H	L

LOGIC DIAGRAM

'158



'157



ABSOLUTE MAXIMUM RATINGS*

Characteristic	Symbol	Ratings	Unit
Supply Voltage Range	V_{CC}	−0.5 to +7.0	V
DC Input Diode Current (V_I<−0.5V or V_I>V_{CC} +0.5V)	I_{ik}	±20	mA
DC Output Diode Current (V_O<−0.5V or V_O>V_{CC} +0.5V)	I_{ok}	±20	mA
Continuous Output Current Per Pin (−0.5V<V_O<V_{CC} +0.5V)	I_o	±35	mA
Continuous Current Through V_{CC} or GND pins		±125	mA
Power Dissipation Per Package	P_d†	500	mW
Storage Temperature Range	T_{stg}	−65 to +150	°C

* Absolute Maximum Ratings are those values beyond which permanent damage to the device may occur. These are stress ratings only and functional operation of the device at or beyond them is not implied. Long exposure to these conditions may affect device reliability.

† Power Dissipation temperature derating:
Plastic Package (N): −12mW/°C from 65°C to 85°C
Ceramic Package (J): −12mW/°C from 100°C to 125°C

RECOMMENDED OPERATING CONDITIONS

Characteristic		Symbol	Value			Unit
			Min	Typ	Max	
Supply Voltage		V_{CC}	4.5	5.0	5.5	V
DC Input & Output Voltages*		V_{IN}, V_{OUT}	0		V_{CC}	V
Operating Temperature Range	KS74AHCT KS54AHCT	T_A	−40 −55		+85 +125	°C °C
Input Rise & Fall Times		t_r, t_f			500	ns

* Unused inputs must always be tied to an appropriate logic voltage level (either V_{CC} or GND)

DC ELECTRICAL CHARACTERISTICS (V_{CC}=5V±10% Unless Otherwise Specified)

Characteristic	Symbol	Test Conditions	T_A=25°C	KS74AHCT T_A=−40°C to +85°C	KS54AHCT T_A=−55°C to +125°C	Unit
			Typ	Guaranteed Limits		
Minimum High-Level Input Voltage	V_{IH}			2.0	2.0	2.0	V
Maximum Low-Level Input Voltage	V_{IL}			0.8	0.8	0.8	V
Minimum High-Level Output Voltage	V_{OH}	V_{IN}=V_{IH} or V_{IL} I_O=−20μA I_O=−4mA	V_{CC} 4.2	V_{CC} −0.1 3.98	V_{CC} −0.1 3.84	V_{CC} −0.1 3.7	V
Maximum Low-Level Output Voltage	V_{OL}	V_{IN}=V_{IH} or V_{IL} I_O=20μA I_O=4mA I_O=8mA	0	0.1 0.26 0.39	0.1 0.33 0.5	0.1 0.4	V
Maximum Input Current	I_{IN}	V_{IN}=V_{CC} or GND		±0.1	±1.0	±1.0	μA
Maximum Quiescent Supply Current	I_{CC}	V_{IN}=V_{CC} or GND I_{OUT}=0μA		8.0	80.0	160.0	μA

AC ELECTRICAL CHARACTERISTICS (Input t_r, $t_f \leq 2$ ns), AHCT157, AHCT158

Characteristic	Symbol	Conditions†	$T_A = 25°C$ $V_{CC} = 5.0V$	KS74AHCT $T_A = -40°C$ to $+85°C$ $V_{CC} = 5.0V \pm 10\%$	KS54AHCT $T_A = -55°C$ to $+125°C$ $V_{CC} = 5.0V \pm 10\%$	Unit
			Typ	Guaranteed Limits		
Maximum Propagation Delay, A or B to Y	t_{PLH}	$C_L = 50pF$	7	11	14	ns
	t_{PHL}		7	11	18	
Maximum Propagation Delay, $\bar{A}$/B to Y	t_{PLH}		9	15	18	ns
	t_{PHL}		9	15	18	
Maximum Propagation Delay, $\bar{G}$ to Y	t_{PLH}		8	14	17	ns
	t_{PHL}		8	14	17	
Maximum Input Capacitance	C_{IN}		5			pF
Power Dissipation Capacitance*	C_{PD}					pF

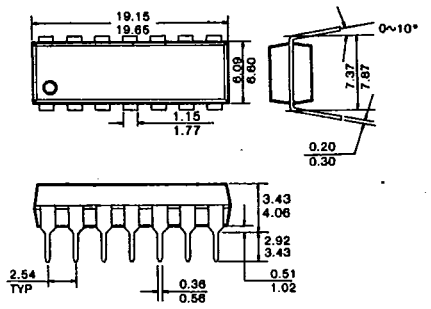
* C_{PD} determines the no-load dynamic power dissipation: $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$.
† For AC switching test circuits and timing waveforms see section 2.

PACKAGE DIMENSIONS

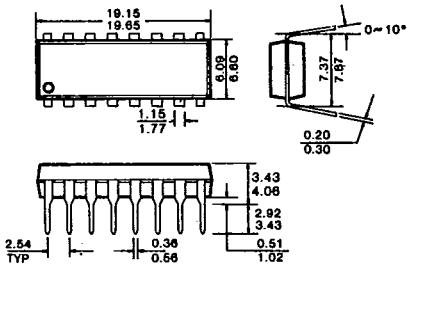
T-90-20

1. PLASTIC PACKAGES

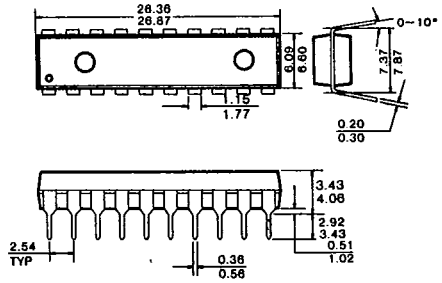
14-Pin Plastic DIP **Units: mm**



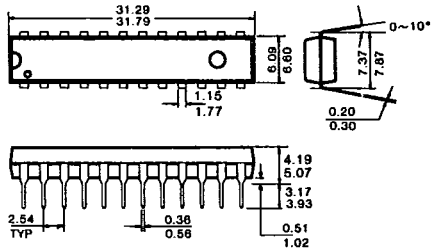
16-Pin Plastic DIP **Units: mm**



20-Pin Plastic DIP **Units: mm**



24-Pin Plastic DIP **Units: mm**



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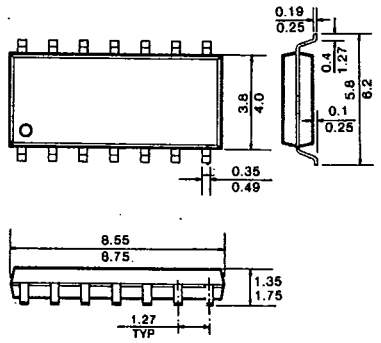
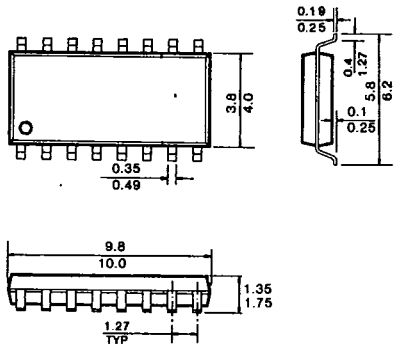
PACKAGE DIMENSIONS

T-90-20

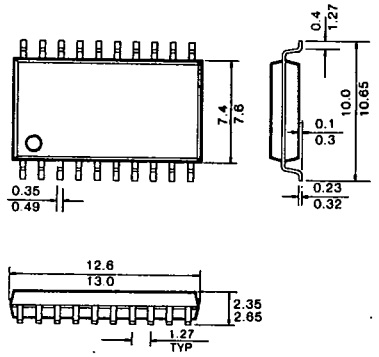
14-Pin SOP Unit: mm



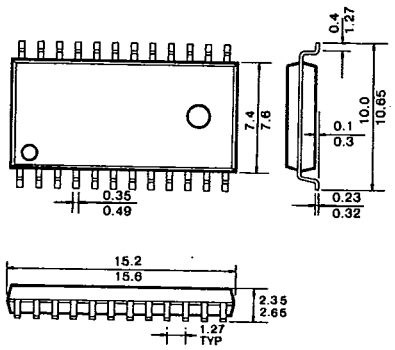
16-Pin SOP Unit: mm



20-Pin SOP Unit: mm



24-Pin SOP Unit: mm

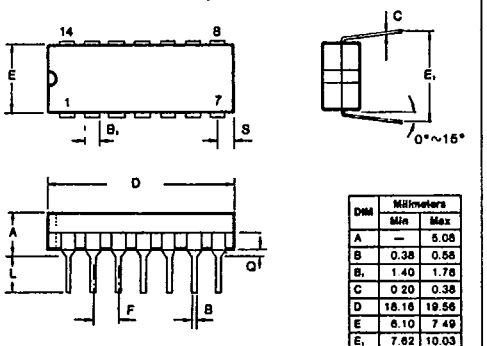


PACKAGE DIMENSIONS

T-90-20

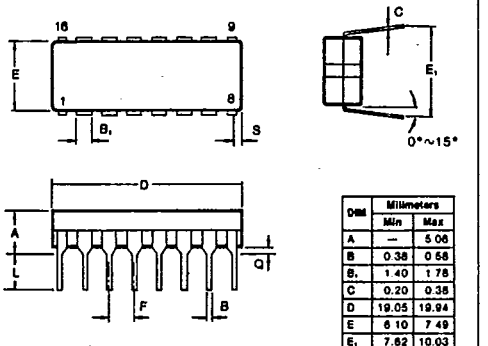
2. CERAMIC PACKAGES

14-Pin Ceramic DIP Units: mm



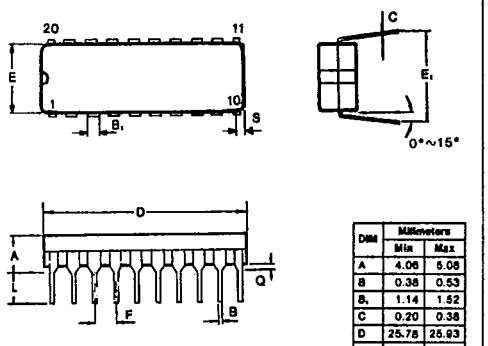
DIM	Millimeters	
	Min	Max
A	—	5.08
B	0.38	0.58
B1	1.40	1.78
C	0.20	0.38
D	18.16	19.56
E	6.10	7.49
E1	7.62	10.03
F	2.54	
L	3.18	4.19
Q	0.51	1.02
S	1.91	2.29

16-Pin Ceramic DIP Units: mm



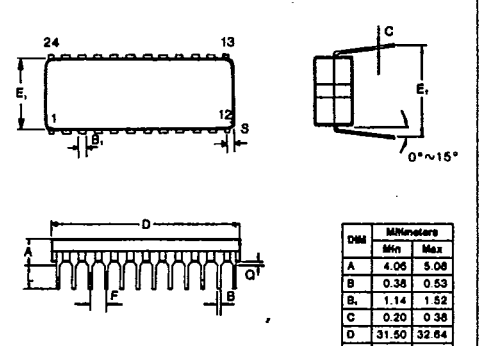
DIM	Millimeters	
	Min	Max
A	—	5.08
B	0.38	0.58
B1	1.40	1.78
C	0.20	0.38
D	19.05	19.94
E	6.10	7.49
E1	7.62	10.03
F	2.54	
L	3.18	4.19
Q	0.51	1.02
S	0.51	1.14

20-Pin Ceramic DIP Units: mm



DIM	Millimeters	
	Min	Max
A	4.06	5.08
B	0.38	0.53
B1	1.14	1.52
C	0.20	0.38
D	25.78	25.93
E	6.10	6.60
E1	7.77	7.98
F	2.54	
L	3.73	4.01
Q	0.38	0.89
S	0.51	1.14

24-Pin Ceramic DIP Units: mm



DIM	Millimeters	
	Min	Max
A	4.06	5.08
B	0.38	0.53
B1	1.14	1.52
C	0.20	0.38
D	31.50	32.64
E	7.24	7.75
E1	7.77	7.98
F	2.54	
L	3.73	4.01
Q	0.508	1.778
S	1.65	1.93

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